

# PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
LG UPLUS CORP.	05/12/2014
EMC TECH CO., LTD.	05/12/2014
<b>RECEIVING PARTY DATA</b>	
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<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	100-095
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	8693498
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<b>NAME OF SUBMITTER:</b>	JAEGYOO JANG
<b>SIGNATURE:</b>	/Jaegyoo Jang/
<b>DATE SIGNED:</b>	05/15/2014
<b>Total Attachments: 2</b>	
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source=Assignment_SHN0097US#page2.tif	

### ASSIGNMENT

WHEREAS, **LG UPLUS CORP.**, a corporation organized and existing under the laws of Republic of Korea, having a place of business at 827 NAMDAEMUNNO5-GA, JUNG-GU, SEOUL, 100-095, REPUBLIC OF KOREA; and **EMC TECH CO., LTD.**, a corporation organized and existing under the laws of Republic of Korea, having a place of business at 206 GAYANG TECHNO TOWN, 1487 GAYANG-DONG, GANGSEO-GU, SEOUL, 157-200 REPUBLIC OF KOREA (hereinafter referred to as "ASSIGNORS") are the owners of the entire right, title and interest in the following United States patent:

U.S. Patent No.: 8,693,498

Patent Issue Date: April 8, 2014


Title: WiFi APPARATUS FOR WIRELESS INTERNET AND WIRELESS INTERNET SYSTEM USING THE SAME

WHEREAS, **LG UPLUS CORP.**, a corporation organized and existing under the laws of Republic of Korea, having a place of business at 827 NAMDAEMUNNO5-GA, JUNG-GU, SEOUL, 100-095, REPUBLIC OF KOREA (hereinafter referred to as "ASSIGNEE"), is desirous of acquiring the entire right, title and interest in and to the above-identified patent and the invention therein disclosed;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignors do hereby assign, sell, transfer and set over unto Assignee all of its right, title and interest in and to the above-identified patent, and any and all applications for patent and patents therefor in any and all countries, including all divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of the application of the above-identified patent.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code.

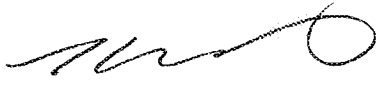
Assignor, **LG UPLUS CORP.**, has caused this Assignment to be executed by its duly authorized officer this 12<sup>th</sup> day of May, 2014.

By:   
[sign above]

Name: CHOI CHAN YOUNG  
[print name above]

Title: Manager  
[title of signer]

Assignor, **EMC TECH CO., LTD.**, has caused this Assignment to be executed by its duly authorized officer this 12<sup>th</sup> day of May, 2014.

By:   
[sign above]

Name: LEE KI CHOON  
[print name above]

Title: CEO  
[title of signer]